



# 100V 15.8mΩ N-Ch Power MOSFET

### Features

- Ultra-low  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100%  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

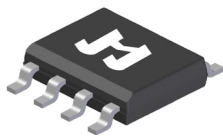
### Product Summary

Parameter	Value	Unit
$V_{DS}$	100	V
$V_{GS(th\_typ)}$	1.9	V
$I_D$ (@ $V_{GS} = 10V$ ) <sup>(1)</sup>	8	A
$R_{DS(ON)\_typ}$ (@ $V_{GS} = 10V$ )	15.8	mΩ
$R_{DS(ON)\_typ}$ (@ $V_{GS} = 4.5V$ )	19	mΩ

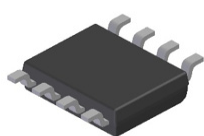
### Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

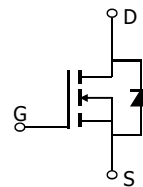
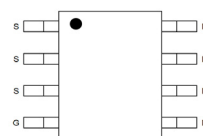
SOP-8L Top View



SOP-8L Bottom View



Top View Pin Configuration

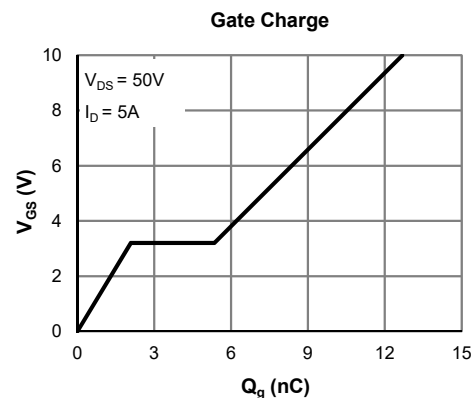
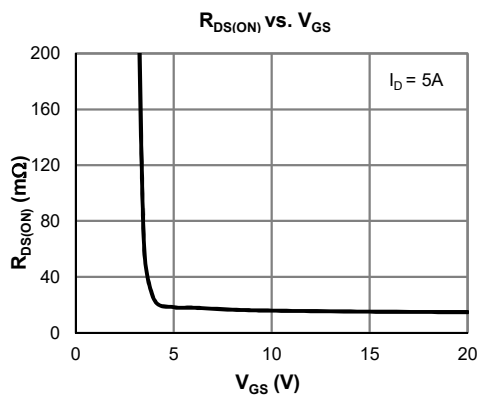


### Ordering Information

Device	Package	# of Pins	Marking	MSL	$T_J$ (°C)	Media	Quantity (pcs)
JMSL1018AP-13	SOP-8L	8	SL1018A	3	-55 to 150	13-inch Reel	2500

### Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DS}$	100	V
Gate-to-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current <sup>(1)</sup>	$I_D$	$T_A = 25^\circ C$	8.1
		$T_A = 70^\circ C$	6.5
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	34	A
Avalanche Current <sup>(3)</sup>	$I_{AS}$	22	A
Avalanche Energy <sup>(3)</sup>	$E_{AS}$	24	mJ
Power Dissipation <sup>(4)</sup>	$P_D$	$T_A = 25^\circ C$	2.5
		$T_A = 70^\circ C$	1.6
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C



**Electrical Characteristics** (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$	100			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 80\text{V}$ , $V_{GS} = 0\text{V}$			1.0	$\mu\text{A}$
					5.0	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}$ , $V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	1.2	1.9	2.5	V
Static Drain-Source ON-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}$ , $I_D = 5\text{A}$		15.8	19.8	m $\Omega$
	$R_{DS(on)}$	$V_{GS} = 4.5\text{V}$ , $I_D = 5\text{A}$		19	25	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5\text{V}$ , $I_D = 5\text{A}$		18		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1\text{A}$ , $V_{GS} = 0\text{V}$		0.70	1.0	V
Diode Continuous Current	$I_S$	$T_A = 25^\circ\text{C}$			2.5	A
<b>DYNAMIC PARAMETERS</b> <sup>(5)</sup>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 50\text{V}$ , $f = 1\text{MHz}$		769		pF
Output Capacitance	$C_{oss}$			171		pF
Reverse Transfer Capacitance	$C_{rss}$			5.1		pF
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}$ , $V_{DS} = 0\text{V}$ , $f = 1\text{MHz}$		1.9		$\Omega$
<b>SWITCHING PARAMETERS</b> <sup>(5)</sup>						
Total Gate Charge (@ $V_{GS} = 10\text{V}$ )	$Q_g$	$V_{GS} = 0$ to $10\text{V}$ $V_{DS} = 50\text{V}$ , $I_D = 5\text{A}$		12.7		nC
Total Gate Charge (@ $V_{GS} = 4.5\text{V}$ )	$Q_g$			6.7		nC
Gate Source Charge	$Q_{gs}$			2.1		nC
Gate Drain Charge	$Q_{gd}$			3.3		nC
Turn-On Delay Time	$t_{D(on)}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 50\text{V}$ $R_L = 10\Omega$ , $R_{GEN} = 6\Omega$		4.3		ns
Turn-On Rise Time	$t_r$			5.1		ns
Turn-Off Delay Time	$t_{D(off)}$			16.7		ns
Turn-Off Fall Time	$t_f$			8.7		ns
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 5\text{A}$ , $dI_F/dt = 100\text{A}/\mu\text{s}$		39		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 5\text{A}$ , $dI_F/dt = 100\text{A}/\mu\text{s}$		30		nC

**Thermal Performance**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient ( $t \leq 10\text{s}$ )	$R_{\theta JA}$	40	50	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient (steady state)	$R_{\theta JA}$	75	90	$^\circ\text{C}/\text{W}$

**Notes:**

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J\_Max} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 100\mu\text{H}$ ,  $V_{GS} = 10\text{V}$ ,  $V_{DS} = 50\text{V}$ ] while its value is limited by  $T_{J\_Max} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

Typical Electrical & Thermal Characteristics

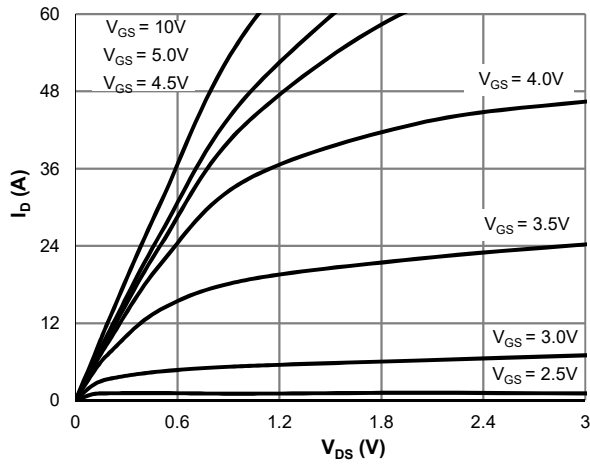


Figure 1: Saturation Characteristics

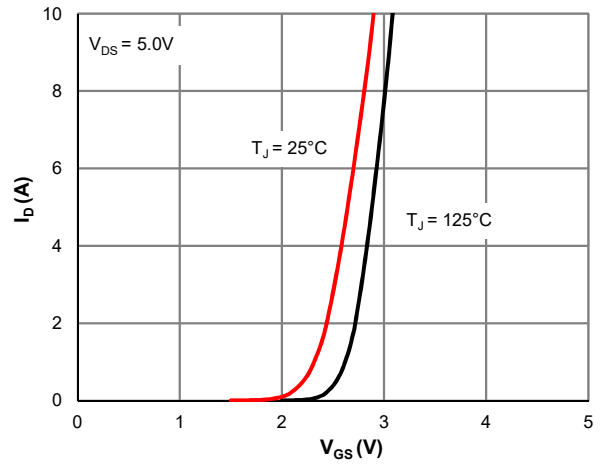


Figure 2: Transfer Characteristics

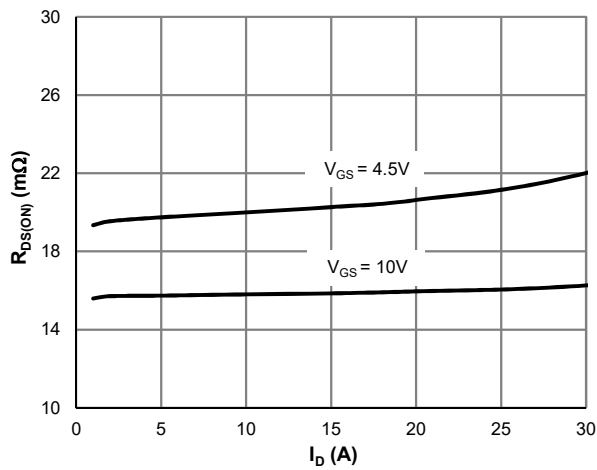


Figure 3:  $R_{DS(ON)}$  vs. Drain Current

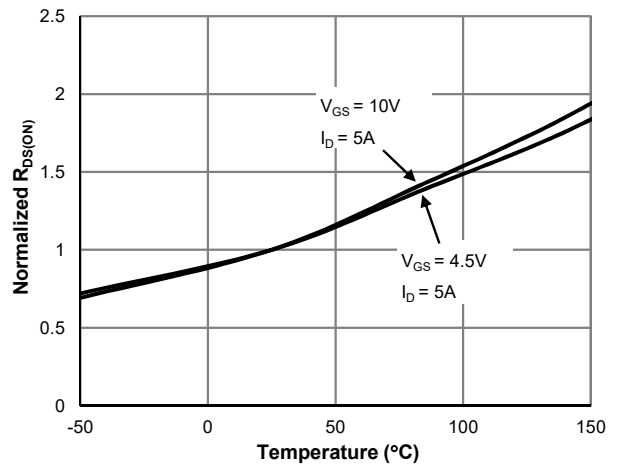


Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature

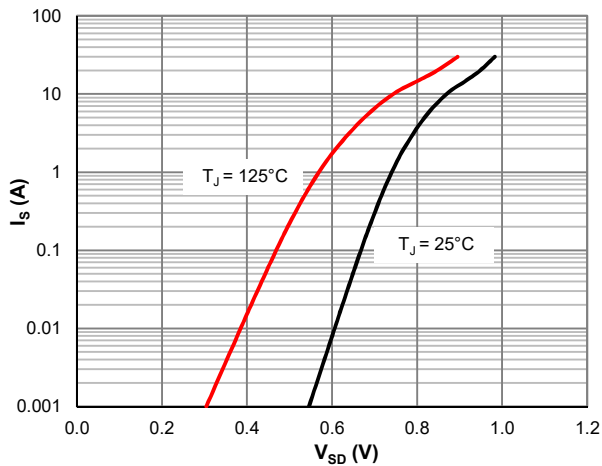


Figure 5: Body-Diode Characteristics

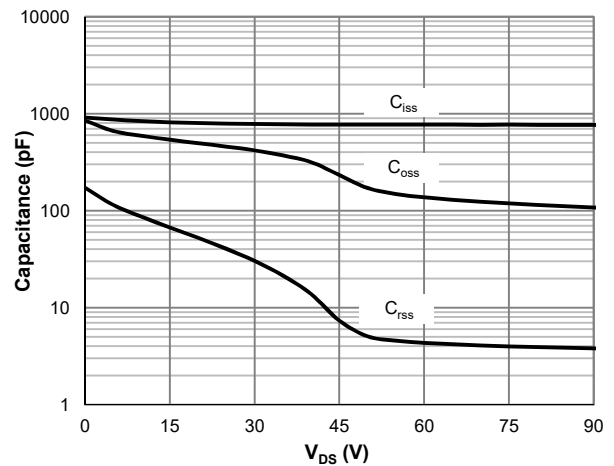


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

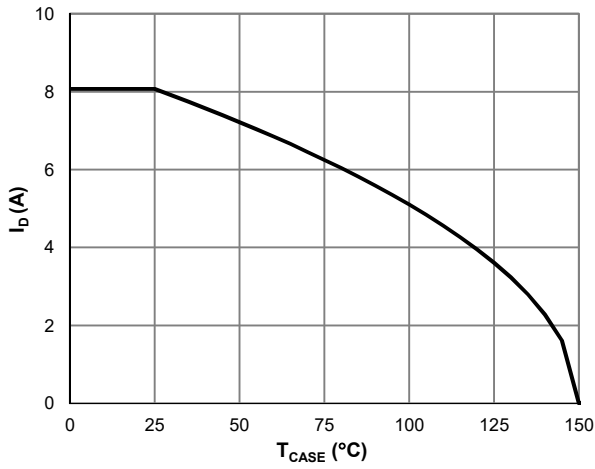


Figure 7: Current De-rating

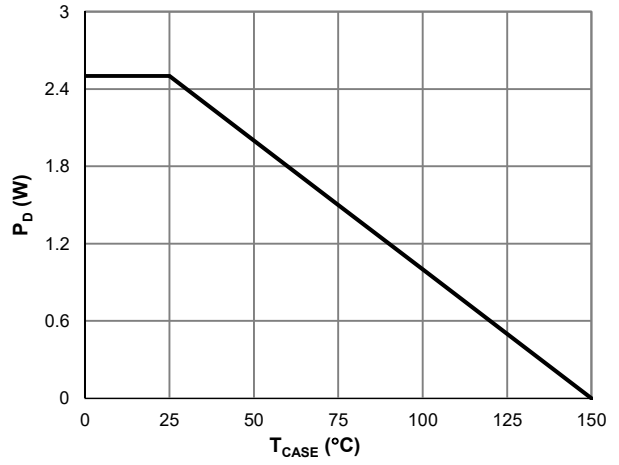


Figure 8: Power De-rating

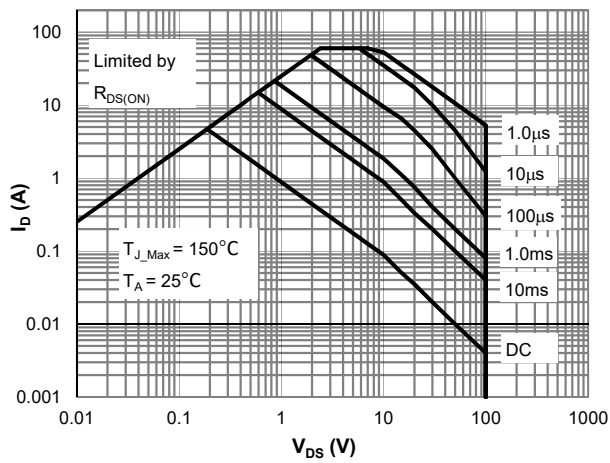


Figure 9: Maximum Safe Operating Area

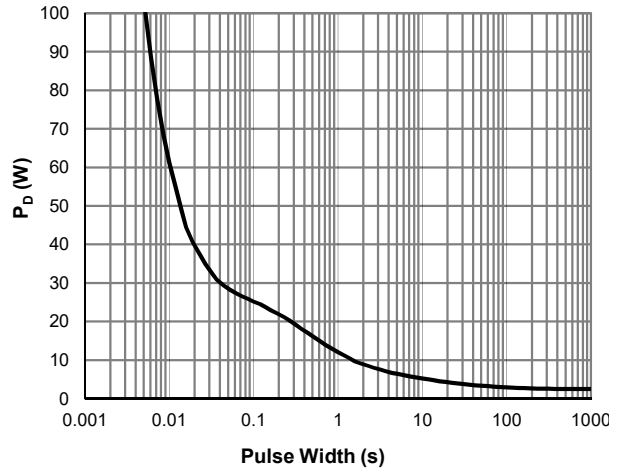


Figure 10: Single Pulse Power Rating, Junction-to-Case

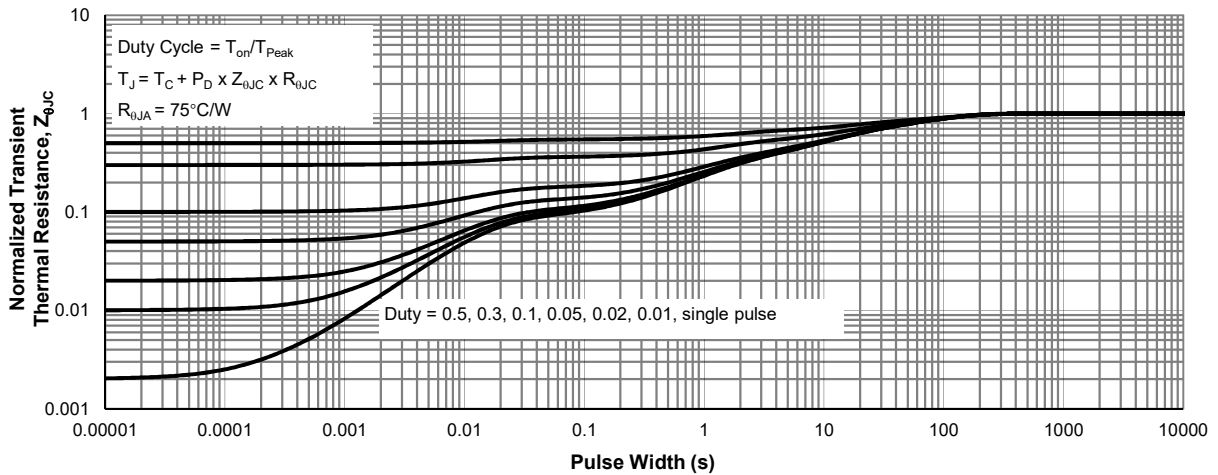
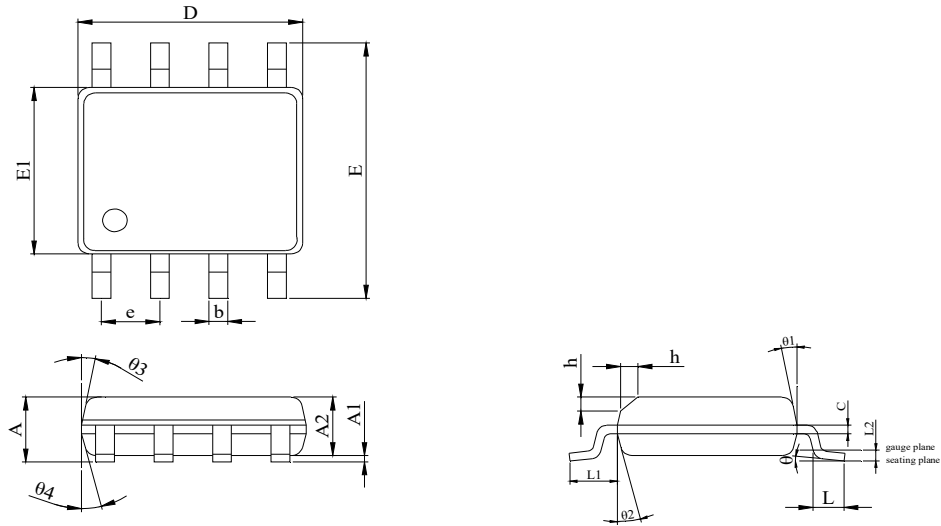
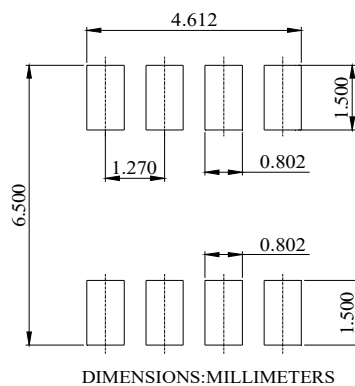


Figure 11: Normalized Maximum Transient Thermal Impedance

**SOP-8L Package Information**
**Package Outline**


DIM	MILLIMETER		
	MIN.	NOM.	MAX.
A	1.35	1.50	1.65
A1	0.05	0.10	0.15
A2	1.35	1.40	1.50
b	0.38	--	0.50
c	0.17	--	0.25
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27(BSC)		
L	0.45	0.60	0.80
L1	1.04 REF		
L2	0.25 BSC		
h	0.30	0.40	0.50
$\theta$	0°	--	8°
$\theta_1$	10°	12°	14°
$\theta_2$	8°	10°	12°
$\theta_3$	10°	12°	14°
$\theta_4$	8°	10°	12°

**Recommended Footprint**


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